



Product Change Notification

108546 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 108546 - 01
Change Title: Intel(R) Carrier Grade Server TIGH2U, PCN 108546-01, Product Material, Added PEM nuts to chassis base allowing support for additional rack mount kits, Reason for Revision: Correct the product name in the title
Date of Publication: June 27, 2008

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

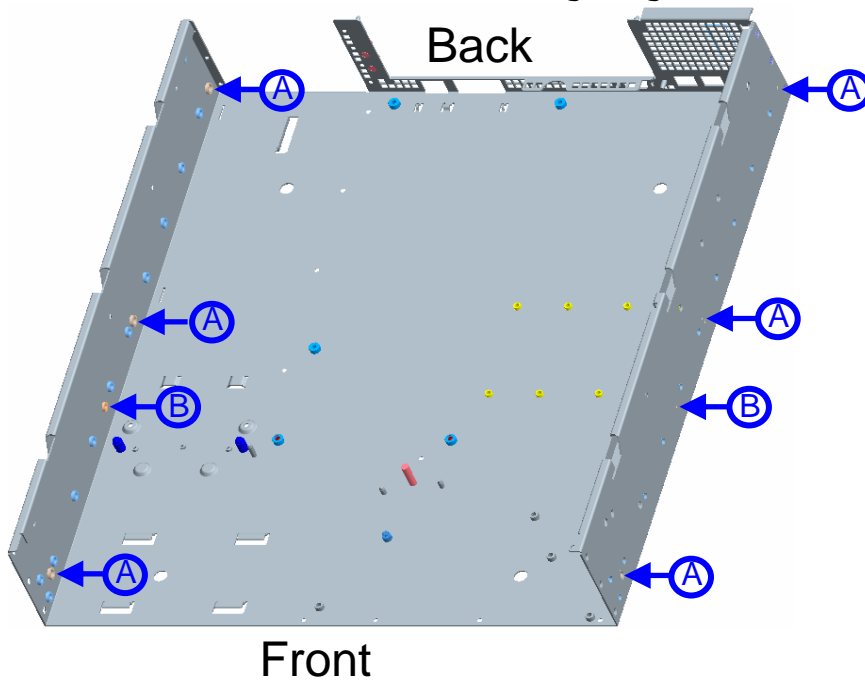
Date Customer Must be Ready to Receive Post-Conversion Material:	Jul 25, 2008
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Description of Change to the Customer:

Reason for Revision: Correct the product name in the title

Intel added a total of eight PEM nuts to the sides of the base chassis to enable support for three additional rack mount kits, AXXBASICRAIL, AXXBASRAIL13, or AXXHERAIL. Ordering information for these kits and other accessory items is listed in the Configuration Guide.

Three PEM nuts (size 10-32, labeled "A") and one PEM nut (size 6-32, labeled "B") are added to each side of the base chassis. See locations labeled "A" and "B" in the following diagram.



The original rack mount kits continue to be supported along with these three new rack mount kits.

Customer Impact of Change and Recommended Action:

Intel anticipates no customer impact based on this change. Customer should evaluate additional rack mount options.

Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change TA	Post Change TA
TLHA0201W	890868	E17592-XXX	E17592-YYY
TLHD0201W	890910	E17593-XXX	E17593-YYY

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
June 10, 2008	00	Originally Published PCN
June 27, 2008	01	Correct the product name in the title